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1. A carrier head for chemical mechanical polishing of a substrate, comprising: a base; and

a flexible membrane extending beneath the base to define a chamber and provide a mounting surface against which a substrate may be positioned, the mounting surface including a low adhesive material to which the substrate does not readily adhere.

2. A carrier head for chemical mechanical polishing of a substrate, comprising: a base, and

a flexible membrane extending beneath the base to define a chamber, the flexible membrane including a core of a first material and an outer layer of a second material having a lower adhesion to the substrate than the first material, an exposed surface of the outer layer providing a mounting surface for the substrate.

- 3. The carrier head of claim 2, wherein the first material is an elastomer and the second material is a polymer.
- 4. The carrier head of claim 2, wherein a thickness of the outer layer is between about 0.1 and 2.0 microns.
- 5. The carrier head of claim 2 wherein a coefficient of friction of the mounting surface against the substrate is less than about .5.
  - 6. The carrier head of claim 2, wherein the second material is polyparaxylylene.
- 7. The carrier head of claim 2, wherein the second material is deposited on the first material.
  - 8. The carrier head of claim 7, wherein the second material is deposited on the first material by gas phase polymerization coating.

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- The carrier head of claim 2, wherein the second material is deposited on 9. selected portions of the first material to form a pattern.
  - A carrier head for chemical mechanical polishing of a substrate, comprising: 10. a base; and

a flexible membrane extending beneath the base to define a chamber, the flexible membrane including an inner portion formed of a first material and an outer portion formed of a second material, the outer portion providing a mounting surface against which a substrate may be positioned and the second material having a lower adhesion to the substrate than the first material.

A flexible membrane for a carrier head, comprising: 11.

a core of a first material; and

an outer layer of a second material formed over the core, an exposed surface of the outer layer providing a mounting surface for a substrate, the second material having a lower adhesion to the substrate than the first material.

A method of moving a substrate with a carrier head, comprising: 12. positioning a substrate against a mounting surface of a flexible membrane of a carrier head, the flexible membrane defining a pressurizable chamber within the carrier head, the flexible membrane including a low adhesion material to which the substrate does not readily adhere;

evacuating the chamber to form a seal between the mounting surface and the substrate;

placing the substrate on a receiving surface; and pressurizing the chamber to break the seal between the substrate and the mounting surface.

A method of making a flexible membrane for a carrier head, comprising: 13. providing a core formed of a first material;

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depositing a second material onto the core to form a layer, the layer providing a mounting surface for a substrate, the second material having a lower adhesion to the substrate than the first material.

- 14. The method of claim 13, wherein the providing step includes providing a core formed of an elastomer.
- 15. The method of claim 13, wherein the depositing step includes depositing polymer.
- 16. The method of claim 13, wherein the depositing step includes depositing polyparaxylylene.
- 17. The method of claim 13, wherein the depositing step forms the layer with a thickness between about 0.1 and 2.0 microns.
- 18. The method of claim 13, wherein the depositing step forms the layer with coefficient of friction against the substrate less than about .5.
- 19. The method of claim 13, wherein the depositing step includes gas phase polymerization coating.
  - 20. The method of claim 13, wherein the depositing step forms the layer on selected portions of the first material to form a pattern.

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